

To our customers,

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## Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: <http://www.renesas.com>

April 1<sup>st</sup>, 2010  
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<http://www.renesas.com>)

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## 2SK1254(L), 2SK1254(S)

Silicon N Channel MOS FET

REJ03G0917-0200  
(Previous: ADE-208-1255)  
Rev.2.00  
Sep 07, 2005

### Application

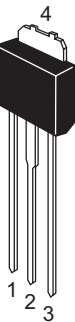
High speed power switching

### Features

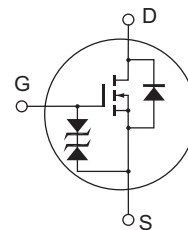
- Low on-resistance
- High speed switching
- 4 V gate drive device
  - Can be driven from 5 V source
- Suitable for motor drive, DC-DC converter, power switch and solenoid drive

### Outline

RENESAS Package code: PRSS0004ZD-A  
(Package name: DPAK(L)-(1))



RENESAS Package code: PRSS0004ZD-C  
(Package name: DPAK(S))



1. Gate
2. Drain
3. Source
4. Drain

## Absolute Maximum Ratings

(Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to source voltage	$V_{DSS}$	120	V
Gate to source voltage	$V_{GSS}$	$\pm 20$	V
Drain current	$I_D$	3	A
Drain peak current	$I_{D(pulse)}^{*1}$	12	A
Body to drain diode reverse drain current	$I_{DR}$	3	A
Channel dissipation	$P_{ch}^{*2}$	20	W
Channel temperature	$T_{ch}$	150	°C
Storage temperature	$T_{stg}$	-55 to +150	°C

Notes: 1.  $PW \leq 10 \mu s$ , duty cycle  $\leq 1\%$   
 2. Value at  $T_C = 25^\circ C$

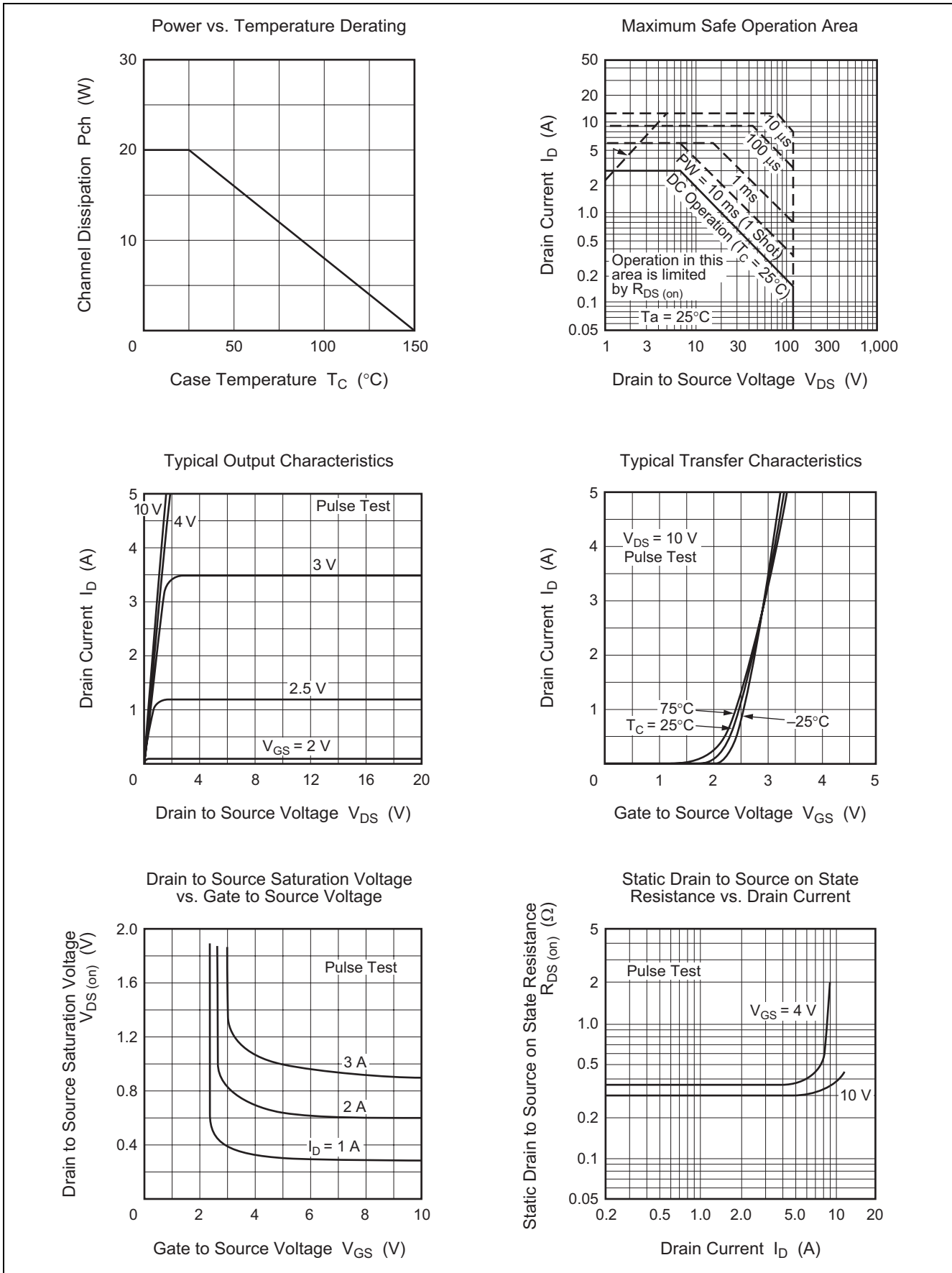
## Electrical Characteristics

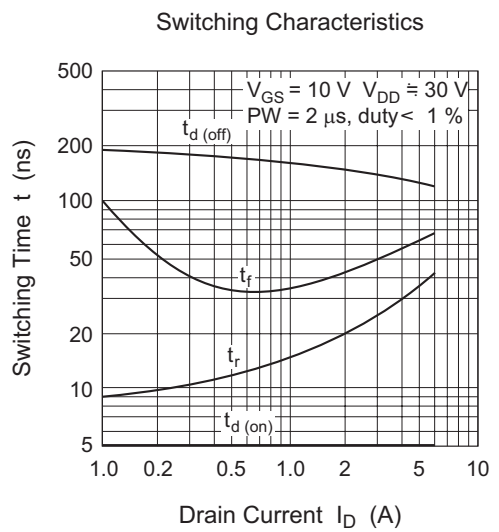
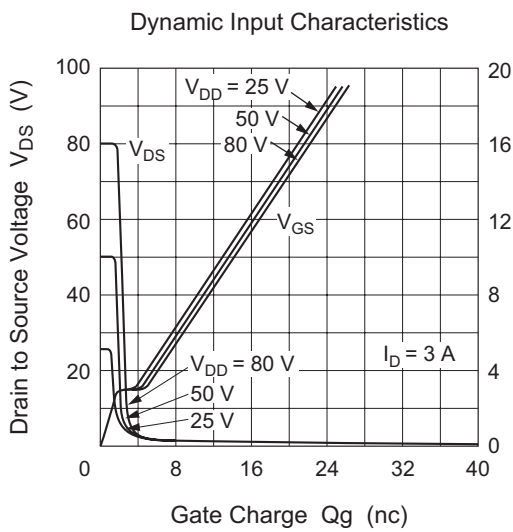
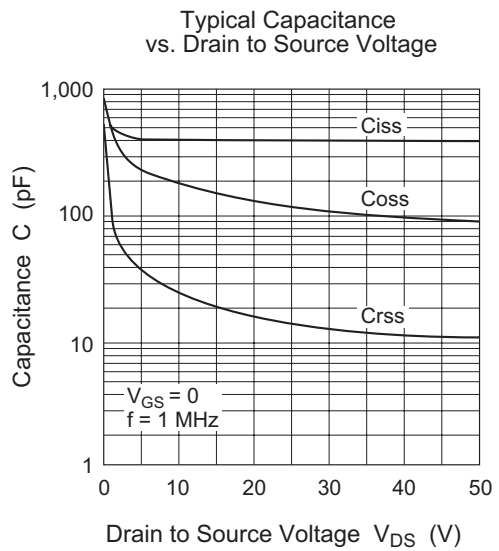
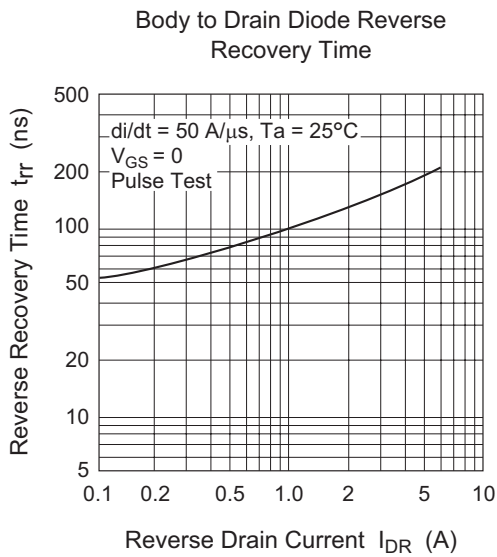
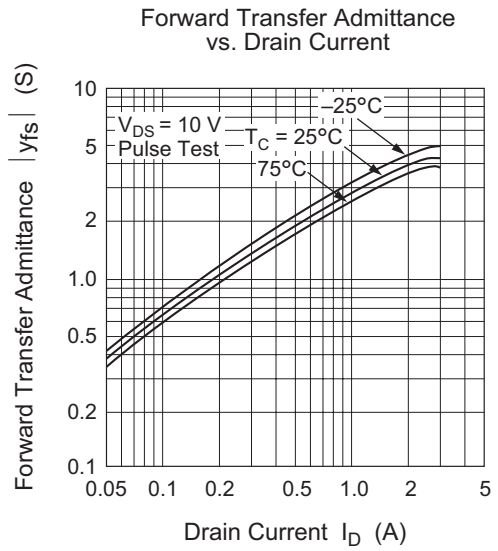
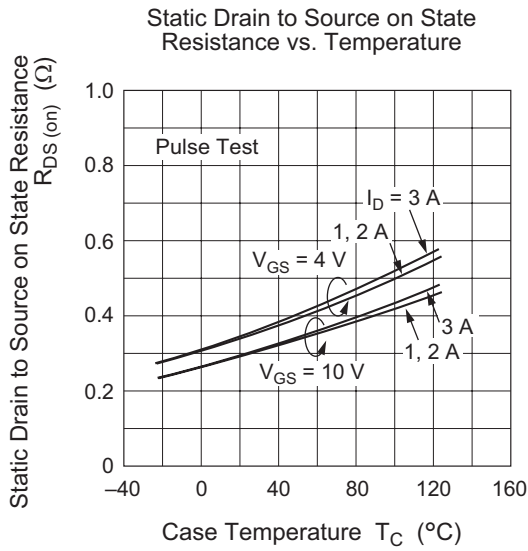
(Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	120	—	—	V	$I_D = 10 \text{ mA}$ , $V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	$\pm 20$	—	—	V	$I_G = \pm 100 \mu A$ , $V_{DS} = 0$
Gate to source leak current	$I_{GSS}$	—	—	$\pm 10$	$\mu A$	$V_{GS} = \pm 16 \text{ V}$ , $V_{DS} = 0$
Zero gate voltage drain current	$I_{DSS}$	—	—	100	$\mu A$	$V_{DS} = 100 \text{ V}$ , $V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	1.0	—	2.0	V	$I_D = 1 \text{ mA}$ , $V_{DS} = 10 \text{ V}$
Static drain to source on state resistance	$R_{DS(on)}$	—	0.30	0.40	$\Omega$	$I_D = 2 \text{ A}$ , $V_{GS} = 10 \text{ V}^{*3}$
		—	0.35	0.55	$\Omega$	$I_D = 2 \text{ A}$ , $V_{GS} = 4 \text{ V}^{*3}$
Forward transfer admittance	$ y_{fs} $	2.4	4.0	—	S	$I_D = 2 \text{ A}$ , $V_{DS} = 10 \text{ V}^{*3}$
Input capacitance	$C_{iss}$	—	420	—	pF	$V_{DS} = 10 \text{ V}$ , $V_{GS} = 0$ , $f = 1 \text{ MHz}$
Output capacitance	$C_{oss}$	—	190	—	pF	
Reverse transfer capacitance	$C_{rss}$	—	25	—	pF	
Turn-on delay time	$t_{d(on)}$	—	5	—	ns	$I_D = 2 \text{ A}$ , $V_{GS} = 10 \text{ V}$ , $R_L = 15 \Omega$
Rise time	$t_r$	—	20	—	ns	
Turn-off delay time	$t_{d(off)}$	—	150	—	ns	
Fall time	$t_f$	—	45	—	ns	
Body to drain diode forward voltage	$V_{DF}$	—	0.95	—	V	$I_F = 3 \text{ A}$ , $V_{GS} = 0$
Body to drain diode reverse recovery time	$t_{rr}$	—	160	—	ns	$I_F = 3 \text{ A}$ , $V_{GS} = 0$ , $di_F/dt = 50 \text{ A}/\mu s$

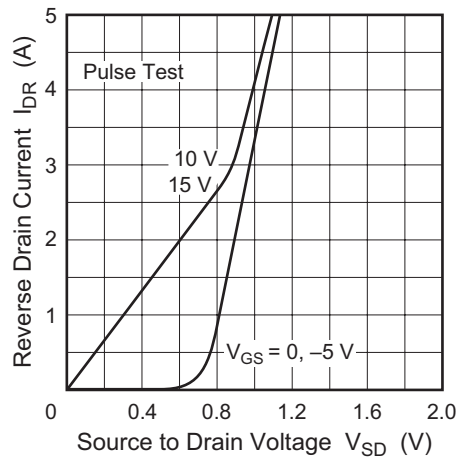
Note: 3. Pulse test

### Main Characteristics

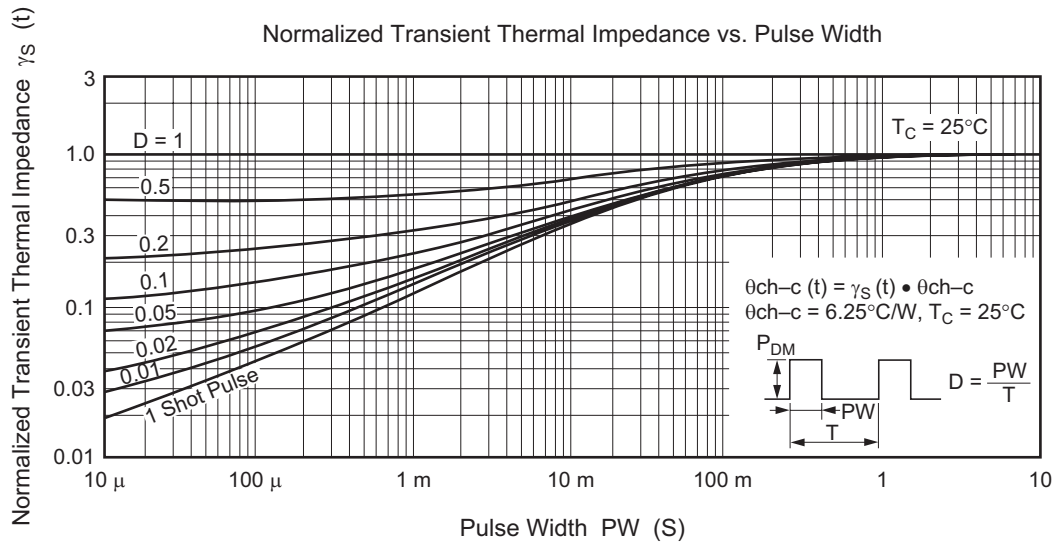




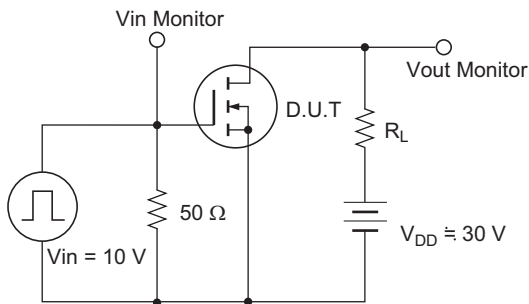
Reverse Drain Current vs. Source to Drain Voltage



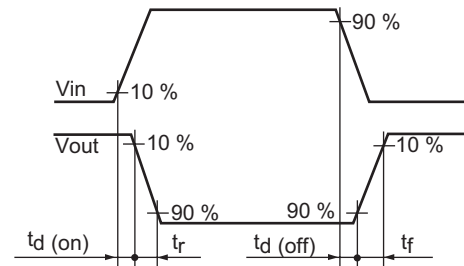
Normalized Transient Thermal Impedance vs. Pulse Width



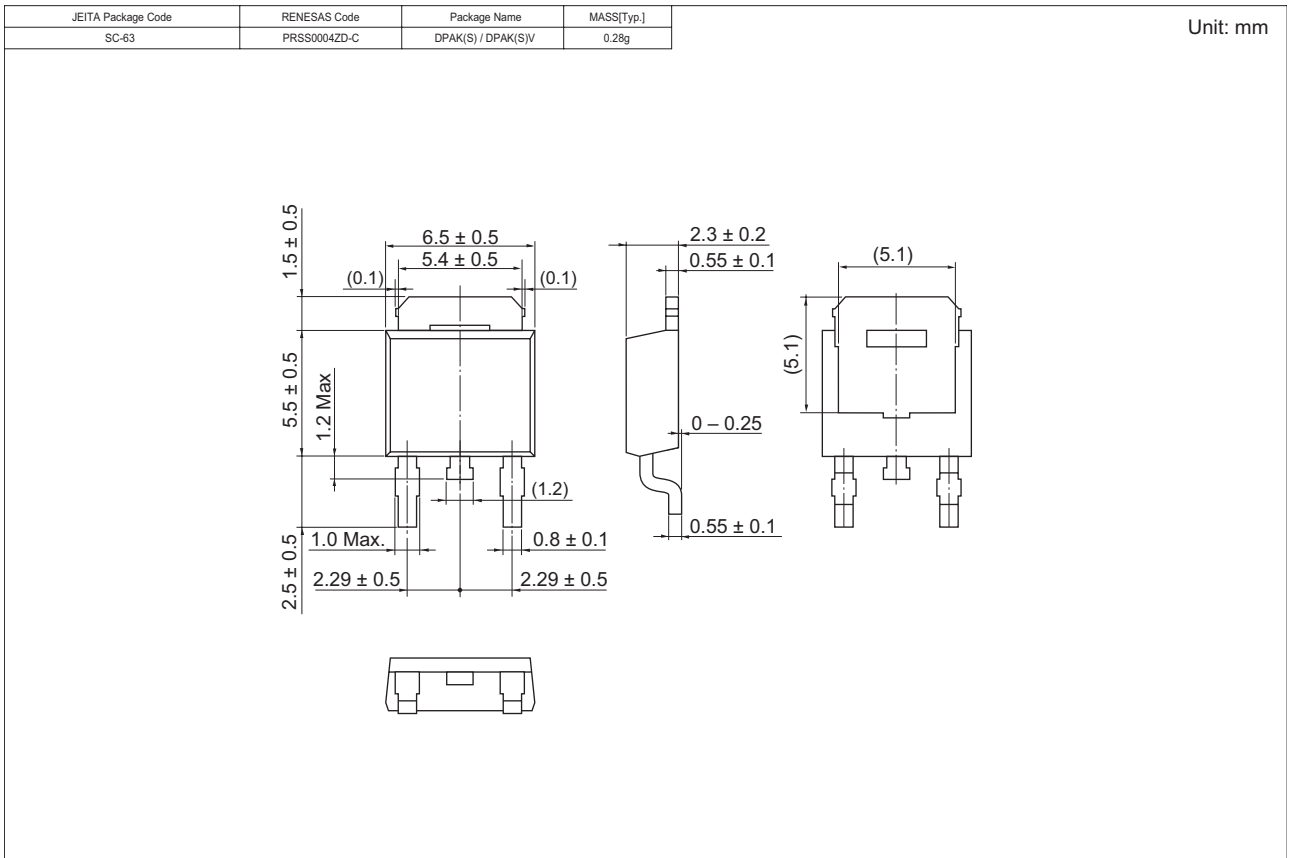
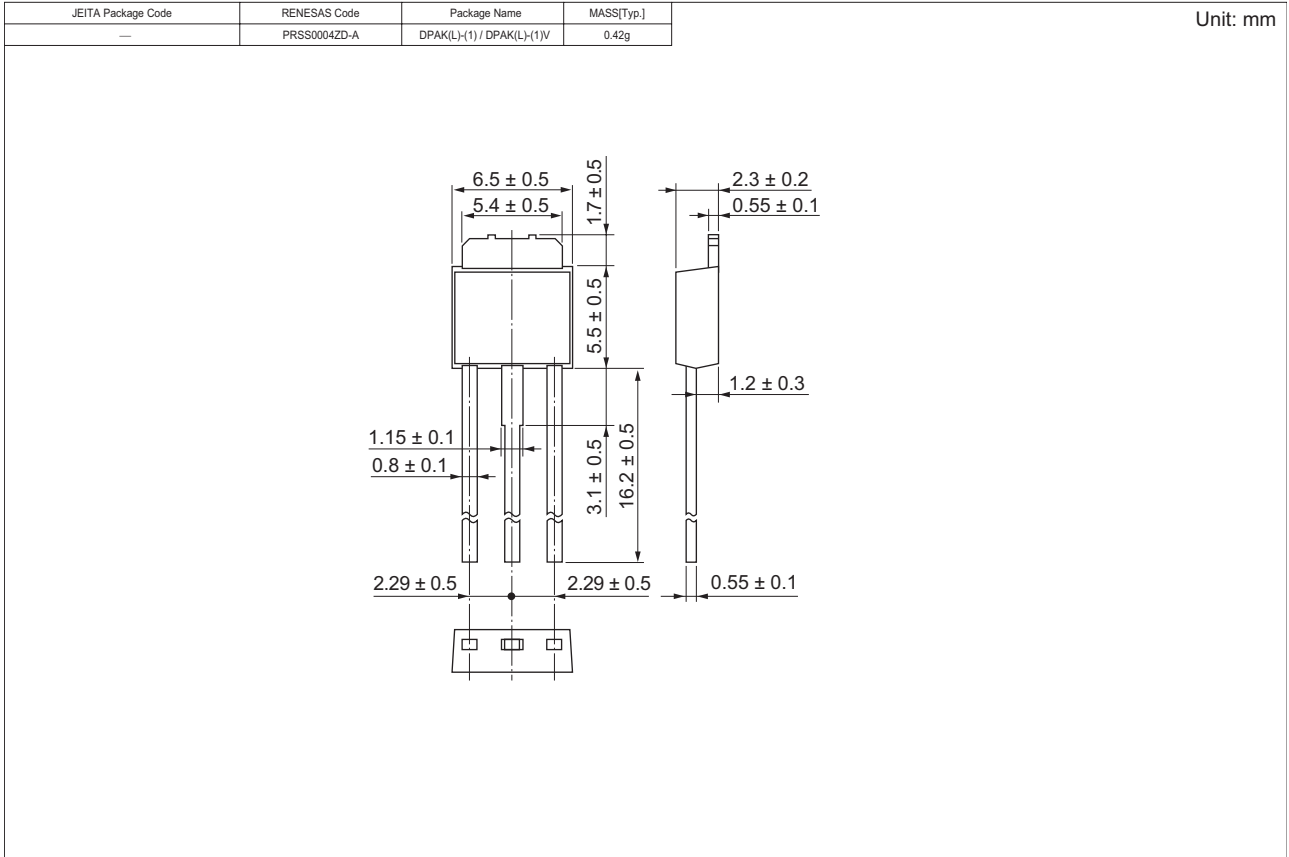
Switching Time Test Circuit



Waveforms



Package Dimensions





### Ordering Information

Part Name	Quantity	Shipping Container
2SK1254L-E	3200 pcs	Box (Sack)
2SK1254STL-E	3000 pcs	Taping

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